Product specification

PIP3103-T

DESCRIPTION

Monolithic temperature and overload protected logic level power MOSFET in **TOPFET2** technology assembled in a 3 pin surface mount plastic package.

APPLICATIONS

General purpose switch for driving

- lamps ٠
- motors
- solenoids •
- heaters •

FEATURES

- TrenchMOS output stage •
- **Current limiting**
- Overload protection •
- •
- Overtemperature protection Protection latched reset by input •
- 5 V logic compatible input level Control of output stage and • • supply of overload protection
- circuits derived from input Low operating input current • permits direct drive by
- micro-controller ESD protection on all pins
- Overvoltage clamping for turn off of inductive loads

QUICK REFERENCE DATA

| SYMBOL | PARAMETER | MAX. | UNIT |
|---------------------|----------------------------------|------|------|
| V _{DS} | Continuous drain source voltage | 50 | V |
| I _D | Continuous drain current | 0.7 | А |
| P _D | Total power dissipation | 1.8 | W |
| T _j | Continuous junction temperature | 150 | °C |
| R _{DS(ON)} | Drain-source on-state resistance | 200 | mΩ |
| | | | |

FUNCTIONAL BLOCK DIAGRAM



PINNING - SOT223

| PIN | DESCRIPTION |
|-----|-------------|
| 1 | input |
| 2 | drain |
| 3 | source |
| 4 | drain (tab) |
| | |



SYMBOL TOPFET



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LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|------------------|--|-------------------------------|------|---------------|------|
| V _{DS} | Continuous drain source voltage ¹ | - | - | 50 | V |
| | Continuous drain current ² | - | - | self limiting | A |
| l I | Continuous input current | clamping | - | 3 | mA |
| I _{IRM} | Non-repetitive peak input current | $t_n \le 1 \text{ ms}$ | - | 10 | mA |
| P _D | Total power dissipation | $T_a = 25^{\circ}C$ | - | 1.8 | W |
| T _{stq} | Storage temperature | - | -55 | 150 | °C |
| T | Continuous junction temperature | normal operation ³ | - | 150 | °C |

ESD LIMITING VALUE

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|----------------|---|---|------|------|------|
| V _c | Electrostatic discharge capacitor voltage | Human body model; C = 250 pF; R = 1.5 k Ω | - | 2 | kV |

OVERVOLTAGE CLAMPING LIMITING VALUES

At a drain source voltage above 50 V the power MOSFET is actively turned on to clamp overvoltage transients.

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|------------------|--------------------------------|--|------|------|------|
| E _{DSM} | Non-repetitive clamping energy | $T_a \le 25^{\circ}C; I_{DM} < I_{D(lim)};$ | - | 100 | mJ |
| E _{DRM} | Repetitive clamping energy | $T_{sp} \le 125^{\circ}C; I_{DM} = 50 \text{ mA};$ f = 250 Hz | - | 5 | mJ |

OVERLOAD PROTECTION LIMITING VALUES

With the protection supply provided via the input pin, TOPFET can protect itself from short circuit loads. Overload protection operates by means of drain current limiting and activating the overtemperature protection.

| SYMBOL | PARAMETER | REQUIRED CONDITION | MIN. | MAX. | UNIT |
|------------------|---------------------------------------|--------------------|------|------|------|
| V _{DDP} | Protected drain source supply voltage | $V_{IS} \ge 4 V$ | - | 35 | V |

THERMAL CHARACTERISTICS

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|--|--|--|------|---------------|---------------|-------------------|
| R _{th j-sp} R _{th j-b} R _{th j-a} | Thermal resistance Junction to solder point Junction to board ⁴ Junction to ambient | Mounted on any PCB Mounted on PCB of fig.22 | - | 12 40 - | 18 - 70 | K/W K/W K/W |

¹ Prior to the onset of overvoltage clamping. For voltages above this value, safe operation is limited by the overvoltage clamping energy.

² Refer to OVERLOAD PROTECTION CHARACTERISTICS.

³ Not in an overload condition with drain current limiting.

⁴ Temperature measured 1.3 mm from tab.

OUTPUT CHARACTERISTICS

Limits are for -40°C \leq T_{mb} \leq 150°C; typicals are for T_{mb} = 25 °C unless otherwise specified

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|----------------------|-------------------------------|--|------|------|------|------|
| | Off-state | $V_{IS} = 0 V$ | | | | |
| V _{(CL)DSS} | Drain-source clamping voltage | I _D = 10 mA | 50 | - | - | V |
| | | $I_{\text{D}} = 200 \text{ mA}; t_{\text{p}} \leq 300 \mu\text{s}; \delta \leq 0.01$ | 50 | 60 | 70 | V |
| I _{DSS} | Drain source leakage current | $V_{DS} = 40 V$ | - | - | 100 | μA |
| | | $T_{mb} = 25 \degree C$ | - | 0.1 | 10 | μΑ |
| | On-state | $V_{\text{IS}} \geq 4 \text{ V; } t_{\text{p}} \leq 300 \mu\text{s; } \delta \leq 0.01$ | | | | |
| R _{DS(ON)} | Drain-source resistance | $I_{\rm D} = 100 {\rm mA}$ | - | - | 380 | mΩ |
| | | T _{mb} = 25 °C | - | 150 | 200 | mΩ |

INPUT CHARACTERISTICS

The supply for the logic and overload protection is taken from the input. Limits are for -40°C $\leq T_{mb} \leq 150$ °C; typicals are for $T_{mb} = 25$ °C unless otherwise specified

| SYMBOL | PARAMETER | CONDITIONS | | MIN. | TYP. | MAX. | UNIT |
|---------------------|---|----------------------------------|--|------------|------------|------------|----------|
| V _{IS(TO)} | Input threshold voltage | $V_{DS} = 5 V; I_{D} = 1 mA$ | T _{mb} = 25°C | 0.6 1.1 | - 1.6 | 2.4 2.1 | V V |
| I _{IS} | Input supply current | normal operation; | V _{IS} = 5 V V _{IS} = 4 V | 100 80 | 220 195 | 400 330 | μΑ μΑ |
| I _{ISL} | Input supply current | protection latched; | V _{IS} = 5 V V _{IS} = 3 V | 200 130 | 400 250 | 650 430 | μΑ μΑ |
| V _{ISR} | Protection reset voltage ¹ | reset time $t_r \ge 100 \ \mu s$ | | 1.5 | 2 | 2.9 | V |
| t _{ır} | Latch reset time | $V_{IS1} = 5 V, V_{IS2} < 1 V$ | | 10 | 40 | 100 | μs |
| V _{(CL)IS} | Input clamping voltage | l _i = 1.5 mA | | 5.5 | - | 8.5 | V |
| R _{IG} | Input series resistance ² to gate of power MOSFET | | $T_{mb} = 25^{\circ}C$ | - | 33 | - | kΩ |

¹ The input voltage below which the overload protection circuits will be reset.

² Not directly measureable from device terminals.

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OVERLOAD PROTECTION CHARACTERISTICS

TOPFET switches off to protect itself when one of the overload thresholds is exceeded. It remains latched off until reset by the input.

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|--------------------|--------------------------------|---|-------------------|---------------|-----------------|-------------|
| | Overload protection | $-40^{\circ}C \le T_{j} \le 150^{\circ}C$ | | | | |
| I _D | Drain current limiting | $V_{IS} = 5 V$ $V_{IS} = 4.5 V$ $V_{IS} = 4 V$ to 5.5 V | 0.8 0.7 0.6 | 1.3 - - | 1.7 - 1.8 | A A A |
| | Short circuit load protection | $V_{IS} = 5 V$ | | | | |
| $P_{D(TO)}$ | Overload power threshold | for protection to operate | - | 17 | - | W |
| T_{DSC} | Characteristic time | which determines trip time ¹ | - | 1.6 | - | ms |
| | Overtemperature protection | from $I_D \ge 280$ mA or $V_{DS} \ge 100$ mV | | | | |
| T _{j(TO)} | Threshold junction temperature | $V_{IS} = 4 V \text{ to } 5.5 V$ | 150 | 165 | - | °C |

SWITCHING CHARACTERISTICS

 $T_a = 25^{\circ}C$; resistive load $R_L = 50 \Omega$; adjust V_{DD} to obtain $I_D = 250 \text{ mA}$; refer to test circuit and waveforms

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|--------------------|---------------------|-------------------------------|------|------|------|------|
| t _{d on} | Turn-on delay time | $V_{IS}: 0 V \Rightarrow 5 V$ | - | 5 | 12 | μs |
| t _r | Rise time | | - | 11 | 30 | μs |
| t _{d off} | Turn-off delay time | $V_{IS}: 5 V \Rightarrow 0 V$ | - | 25 | 65 | μs |
| t _f | Fall time | | - | 14 | 35 | μs |

REVERSE DIODE LIMITING VALUE

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|----------------|----------------------------|------------------------------------|------|------|------|
| I _S | Continuous forward current | $T_{mb} \le 25$ °C; $V_{IS} = 0$ V | - | 2 | А |

REVERSE DIODE CHARACTERISTICS

Limits are for -40°C \leq T_{mb} \leq 150°C; typicals are for T_{mb} = 25°C unless otherwise specified

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|-----------------|-----------------------|---|------|------|------|------|
| V_{SDO} | Forward voltage | $I_{s} = 2 \text{ A}; V_{Is} = 0 \text{ V}; t_{p} = 300 \ \mu \text{s}$ | - | 0.83 | 1.1 | V |
| t _{rr} | Reverse recovery time | not applicable ² | - | - | - | - |

¹ Trip time $t_{d \, sc}$ varies with overload dissipation P_D according to the formula $t_{d \, sc} \approx T_{DSC} / [P_D / P_{D(TO)} - 1]$.

² The reverse diode of this type is not intended for applications requiring fast reverse recovery.

Normalised RDS(ON) = $f(T_i)$

100

TYP.

5

6

150

8

PowerMOS transistor Logic level TOPFET

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С

8

12

16 VDS / V

Fig.4. Typical on-state characteristics, $T_j = 25$ °C. $I_D = f(V_{DS})$; parameter V_{IS} ; $t_p = 300 \,\mu$ s

20

24

28

32

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MECHANICAL DATA

| <complex-block></complex-block> | Plastic su | rface | e mo | unted | pacl | age; | colle | ctor p | oad fo | or goo | d hea | t trar | nsfer; | 4 lea | ds | | | SOT22 |
|--|---|------------|--------------|--------------|------------|--------------|------------|------------|--------|----------------|----------------|------------|--------------|-------|-----|--------|------|-------|
| Image: constrained of the state of the | | | | | | | | | | A | | | | | | | | |
| scale DIMENSIONS (mm are the original dimensions) UNIT A A1 bp b1 c D E e e1 HE Lp Q v w y mm 1.8 0.10 0.80 3.1 0.32 6.7 3.7 1.0 0.0 7.3 1.1 0.95 0.0 0.4 0.4 | $ \begin{array}{c} & & & \\ & & & & \\ & & & & \\ & & & \\ & & & \\ & & & \\ & & & & \\ & & & \\ & & & & \\ & & & $ | | | | | | | | | | | | | | | | | |
| UNIT A A1 bp b1 c D E e e1 HE Lp Q v w y mm 1.8 0.10 0.80 3.1 0.32 6.7 3.7 1.0 0.0 7.3 1.1 0.95 0.0 0.4 0.4 | scale | | | | | | | | | | | | | | | | | |
| mm 1.8 0.10 0.80 3.1 0.32 6.7 3.7 4.6 2.3 7.3 1.1 0.95 0.2 0.1 0.1 | | | | | | | | Е | е | e ₁ | Η _E | Lp | Q | v | w | у | | |
| | mm | 1.8 1.5 | 0.10 0.01 | 0.80 0.60 | 3.1 2.9 | 0.32 0.22 | 6.7 6.3 | 3.7 3.3 | 4.6 | 2.3 | 7.3 | 1.1 0.7 | 0.95 0.85 | 0.2 | 0.1 | 0.1 | | |
| OUTLINE VERSION REFERENCES EUROPEAN PROJECTION ISSUE DATE SOT222 IEC JEDEC EIAJ PROJECTION 96-11-11 | VERSION | | | | | | | | FEREN | | | | | | | SOJEC. | TION | |
| 97-02-28 | SOT223 | | | | | | | | | | | | | | | | Ŷ | |

³ For further information, refer to surface mounting instructions for SOT223 envelope. Epoxy meets UL94 V0 at 1/8". Net Mass: 0.11 g

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MOUNTING INSTRUCTIONS



PRINTED CIRCUIT BOARD



PIP3103-T

DEFINITIONS

| DATA SHEET STATUS | | | | | | | |
|-----------------------|--------------------|---|--|--|--|--|--|
| DATA SHEET STATUS⁴ | PRODUCT STATUS⁵ | DEFINITIONS | | | | | |
| Objective data | Development | This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice | | | | | |
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| | | | | | | | |

Limiting values

Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

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